

2.0±0.1

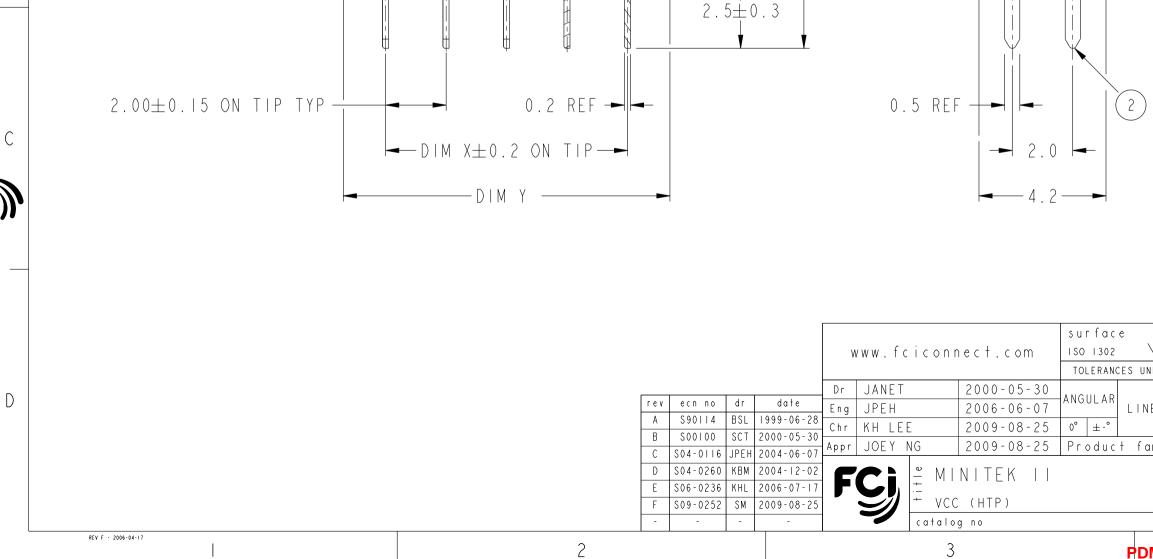
3

PC BOARD THK: 0.9 TO I.3

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► 2.0±0.1 TYP

— DIM X ±0.13——►

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4.5 REF

7 REF

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Ø0.7±0.1

RECOMMENDED MOUNTING HOLE LAYOUT

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CONFIDENTIAL						
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CES UNLESS	OTHERWISE	SPECIFIED		-		
	0.X	±-	size	Scale	:	
LINEAR	0.XX	±0.25	A 3	8:1		D
	0.XXX	±-	ECN	S09-02	53	
t family			Spec ref		-	
		0 L			Rev.	
		dwg	63453	}	F	
		CUS	TOMER	sheet I of	2	

STATUS: Released Printed: Dec 21, 2010

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	PRODUCT NO	PRODUCT NO	POS	DIM X	DIM Y	
	63453-X04	63453-X04LF(8)	2 X 2	2	4.8	P
	X 0 6	X06LF A	2 X 3	4	6.8	T
	X 0 8	X08LF	2 X 4	6	8.8	
CONFIDENTIAL	X 0	XIOLF	2 X 5	8	10.8	
	X 2	XI2LF	2 X 6	10	12.8	
Z	X 4	XI4LF	2 X 7	12	4.8	
Ш	X 6	XI6LF	2 X 8	4	16.8	
	X 8	XI8LF	2 X 9	16	18.8	
<u> </u>	- X20	X20LF	2 X I O	18	20.8	
Z	X 2 2	X22LF	2 X I I	20	22.8	
Ö	X 2 4	X24LF	2 X I 2	22	24.8	(
U	X 2 6	X26LF	2 X I 3	24	26.8	(
$\overline{\Box}$	X 2 8	X28LF	2 X I 4	26	28.8	
<mark>Ю</mark> в	X 3 0	X 3 0 L F	2 X I 5	28	30.8	
	X 3 2	X32LF	2 X I 6	30	32.8	
	X 3 4	X34LF	2 X I 7	32	34.8	
	Х36	X36LF	2 X I 8	34	36.8	
	X 3 8	X 38LF	2 X I 9	36	38.8	
	X 4 0	X40LF	2 X 2 0	38	40.8	
	X 4 2	X42LF	2 X 2 I	40	42.8	
Ŭ Ŝ	X 4 4	X 4 4 L F	2 X 2 2	42	44.8	
Ľ.	X 4 6	X46LF	2 X 2 3	4 4	46.8	
	X 4 8	X48LF ♥	2 X 2 4	46	48.8	
С	X 5 0	X 5 0 L F (8)	2 X 2 5	48	50.8	(
roperty of and embodies CONFIDENTIAL and n of FCL. No part of the information may be used in any way or disclosed to tten consent of FCL. Copyright FCL.	Р I С К - Ф 0.50	UP CAP (.02 E 			► 5.4 →	F

PART NUMBER INFORMATION



NOTES:

I.MATERIAL :

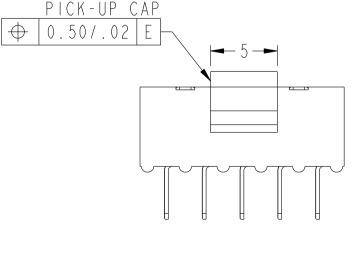
BODY : GLASS FILLED PCT UL 94V-O BLACK TERMINAL : PHOSPHOR BRONZE

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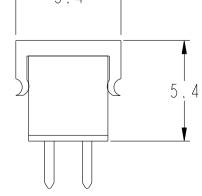
- (2)CUT SURFACE IS UNPLATED
- (3)TERMINAL RETENTION FORCE 0.5 Kg MIN
- 4. TOLERANCE UNLESS OTHERWISE NOTED ± 0.25
- 5. FOR 63453-XI6TR ONLY (TAPE AND REEL PACKAGING) A PICK-UP CAP IS PROVIDED IN THE CENTRE OF THE PRODUCT (SEE FIG.I) FOR PICK AND PLACE APPLICATION. PICK-UP CAP TIGHTNESS IS 7LB MAX.
- 6. THE HOUSING WILL WITHSTAND EXPOSURE TO 255° C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
- 7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR IO SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57MM MINIMUM THICK CIRCUT BOARD.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER (8)COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 9. A $/_{\rm F}$ symbol will be next to any dimension, view or note WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.

		3			PDM
Pro/	E file	catalo	g no		
	Y	+ VC(C (HTP)		
F	Ċì		NITEK II		
Appr	JOEY I	NG	2009-08-25	Model	Revis
Chr	KH LEE		2009-08-25	Model	Name
Eng	JPEH		2006-06-07	Produc	t fam
Dr	JANET		2000-05-30		
Pla	ting/F	inish	-		180
Неа	ttreat		-]
Mat	code		-		surfac
Mat	erial		-		Spec

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REV E - 2006-04-



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PLATING	DESCRIPTION
0	0.2 µm Au
	0.76 µm Au
2	UNASSIGNED
3	0.38 µm Au

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-		CUSTOMER			sheet 2 of	2	
M: Rev:F		STATUS:Re	leas	ea Pi	rinted: Dec 21.	2010	